Your path to robust and reliable in-vehicle networking
Infineon’s automotive networking solutions

www.infineon.com/automotive-networking
## Contents

**Introduction** 4

**Product overview** 7
- Automotive transceivers 8
- System Basis Chips (SBCs) 14
- Infineon® Embedded Power ICs 22
- AURIX™ microcontroller family 29

**Support material** 32
- Automotive transceivers 32
- System Basis Chips (SBCs) 32
- Embedded Power 33
- AURIX™ microcontroller family 34

**Package information** 35
Automotive networking technology is evolving fast, driven by a number of key trends. With a continuously increasing quantity of cars on the road and rising fuel costs, demand for energy efficiency is steadily growing. Worldwide legislation is establishing ever-stricter caps on CO₂ emissions. The spotlight is also on functional safety. With the ISO 26262 automotive standard increasingly moving into applications that were not typically safety-relevant, the bar is moving upwards and we are seeing increasingly granular system safety concepts. At the same time, complexity is on the incline. Growing consumer expectations are pushing for new and innovative comfort and safety features also in low-end segments, and this, in turn, is putting pressure on semiconductor manufacturers to reduce complexity through hardware/software compatibility and design-in support.

Last but not least, standardized, high-performance communication interfaces and protocols are needed to support the growing volume of data shared across automotive networks. CAN and LIN are the most commonly used in-vehicle networking interfaces. High-speed infotainment tends, however, to rely on Ethernet, MOST and LVDS, but these involve high implementation costs. CAN Partial Networking and CAN Flexible Data-rate (e.g. CAN FD) can help to balance the cost performance ratio here.

World leader in automotive electronics for over 40 years, we actively engage with many industry, standardization and research organizations to drive in-vehicle networking innovations capable of meeting today's demands for energy efficiency, safety, smooth interfacing and complexity management. Our broad portfolio extends from stand-alone transceivers through system basis chips to Embedded Power solutions for CAN, LIN and FlexRay protocols. We also offer microcontrollers with enhanced communication capabilities to support multiple protocols. All of our products are designed to deliver the exceptional high levels of ESD robustness and EMC performance required for harsh automotive environment. And to ease and accelerate your design-in process, we offer a range of demo boards, configuration tools, tool chains and development platforms.
Infineon is actively participating as a member in several standardization groups and is also funding some research projects with major OEM’s in terms of networking:

**Local Interconnect Network (LIN)** is used to interconnect sensors, actuators and control modules where the high bandwidth and fast reaction time is not required. LIN is mainly used for comfort functions.

**Controller Area Network (CAN)** also called classical CAN is the most used communication network in automotive applications and allows communication speeds up to 1 Mbit/s.

**CAN Flexible Data-Rate (CAN FD)** is the successor of the classical CAN for faster communication with communication speeds up to 5 Mbit/s and increased payload providing up to 64 data bytes per frame.

**CAN Partial Networking (CAN PN)** also known as CAN with selective wake feature has been introduced to reduce the current consumption on vehicle level by enabling to switch off or on dedicated electronic control units (ECUs).

**FlexRay** provides up to 10 Mbit/s communication speed per channel for advanced in-vehicle networks. It provides fault-tolerant communication for safety related applications.

**Ethernet** is the newest automotive network providing not only improved bandwidth for e.g. 360° surround view monitoring, but also lower latencies for control applications.
Infineon automotive networking products
› Comprehensive product portfolio of standalone transceivers, system basis chips and Embedded Power solutions
› Microcontrollers with enhanced communication capabilities to support flexible communication protocols

As World leader in automotive electronics for over 40 years, Infineon focuses on the in-vehicle networking, a major driver today for innovation in the automotive field, meeting the ever-increasing demand of consumers for energy efficiency, mobility and security.

With over fifteen years’ experience developing communication interfaces, Infineon offers a broad product portfolio of standalone transceivers, System Basis Chips (SBCs) and Embedded Power solutions for CAN, LIN and FlexRay networks. AURIX™ microcontrollers with enhanced communication capabilities to support flexible communication protocols such as LIN, SPI, I²C, CAN, CAN FD, FlexRay, Ethernet, DigRF/LVDS complement the offering.

Continuously improving its SPT chip technology, Infineon provides solutions for the challenges faced by the automotive industry, featuring outstanding ESD robustness and best in class EMC performance in order to fulfill even the future OEM requirements.

In this brochure Infineon has put together its standalone transceiver, system basis chip, Embedded Power and AURIX™ microcontroller portfolio, with a detailed description of their distinctive key features and benefits.

For more detailed information please visit the Infineon website at www.infineon.com/automotive-networking or contact your sales or distribution partners www.infineon.com/WhereToBuy.
## Product overview

<table>
<thead>
<tr>
<th></th>
<th>LIN</th>
<th>CAN FD</th>
<th>CANFD + LIN</th>
<th>FlexRay</th>
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1) In development
Automotive transceivers

Due to the ever-increasing demand for data exchange in modern vehicles, the automotive industry implemented networks such as CAN (Controller Area Network), LIN (Local Interconnect Network) and FlexRay protocol-based bus systems.

Infineon offers a broad product portfolio of automotive transceivers – all of which are perfectly suited and designed to withstand the harsh automotive environment – for the various automotive bus segments.

Different transceiver types are used in accordance with the respective vehicle network architecture and the related ECU supply path. Infineon transceivers ensure reliable communication and help minimize the current consumption and associated CO₂ emissions at the vehicle level. Thanks to their high performance, ruggedness and reliable communication, Infineon’s transceiver products offer the ultimate in value.

www.infineon.com/automotive-transceivers
Infineon offers a complete LIN transceiver and new LIN LDO family in standard DSO-8 as well as tiny TSON-8 packages.

Selection tree – Automotive LIN transceivers

### Product overview

<table>
<thead>
<tr>
<th>Product name</th>
<th>Transmission rate (max)</th>
<th>Low-power mode Iq [µA] (max)</th>
<th>Bus wake-up capability</th>
<th>Wake-up inputs</th>
<th>Number of channels</th>
<th>Bus failure management</th>
<th>Fast programming</th>
<th>Package[^1]</th>
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<td>•</td>
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<td>TLE7257LE</td>
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<tr>
<td>TLE7258SJ</td>
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<tr>
<td>TLE7258LE</td>
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<td>&lt; 15 sleep mode</td>
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<tr>
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</tbody>
</table>

[^1]: See packages on page 36
[^2]: Coming Q2/2017

www.infineon.com/automotive-transceivers
Automotive transceivers

Classical CAN transceivers are available in standard DSO-8 and DSO-14 packages, along with tiny leadless TSON-8 packages.

CAN transceivers for flexible data-rate are making CAN faster and do support data-rates up to 5 Mbits/s.

CAN transceivers for partial networking are improving energy efficiency and making cars greener.

Block diagram example of high-speed CAN: TLE7250V

![Block diagram example of high-speed CAN: TLE7250V](www.infineon.com/automotive-transceivers)
## Selection tree – Automotive CAN and CAN FD transceivers

### High-speed CAN (ISO 11898)

#### Wake

<table>
<thead>
<tr>
<th>Product name</th>
<th>Transmission rate (max)</th>
<th>Low-power mode ( I_q ) [( \mu A )] (max)</th>
<th>Bus wake-up capability</th>
<th>Wake-up inputs</th>
<th>Number of channels</th>
<th>Bus failure management</th>
<th>CAN FD</th>
<th>Package¹</th>
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<tr>
<td>TLE6250G</td>
<td>1 Mbit/s</td>
<td>(&lt; 10 @ 5 \text{ V stand-by})</td>
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<td></td>
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<td></td>
<td>DSO-8</td>
<td></td>
</tr>
<tr>
<td>TLE6250GV33</td>
<td>1 Mbit/s</td>
<td>(&lt; 10 @ 5 \text{ V stand-by})</td>
<td>1</td>
<td></td>
<td></td>
<td></td>
<td>DSO-8</td>
<td></td>
</tr>
<tr>
<td>TLE7250G</td>
<td>1 Mbit/s</td>
<td>(&lt; 15 @ 5 \text{ V stand-by})</td>
<td>1</td>
<td></td>
<td></td>
<td></td>
<td>DSO-8</td>
<td></td>
</tr>
<tr>
<td>TLE7250GVIO</td>
<td>1 Mbit/s</td>
<td>(&lt; 15 @ 5 \text{ V stand-by})</td>
<td>1</td>
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<td>DSO-8</td>
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</tr>
<tr>
<td>TLE8250G</td>
<td>1 Mbit/s</td>
<td>(&lt; 15 @ 5 \text{ V stand-by})</td>
<td>1</td>
<td></td>
<td></td>
<td></td>
<td>DSO-8</td>
<td></td>
</tr>
<tr>
<td>TLE8250GVIO</td>
<td>1 Mbit/s</td>
<td>(&lt; 15 @ 5 \text{ V stand-by})</td>
<td>1</td>
<td></td>
<td></td>
<td></td>
<td>DSO-8</td>
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</tr>
</tbody>
</table>

**NEW!**
| TLE7250SJ TLE8250SJ | 2 Mbit/s | \(< 12 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE7250LE | 2 Mbit/s | \(< 12 @ 5 \text{ V power save mode}\) | 1 | ● | TSON-8 |

**NEW!**
| TLE7250VSJ TLE8250VSJ | 2 Mbit/s | \(< 8 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE7250VLE | 2 Mbit/s | \(< 8 @ 5 \text{ V power save mode}\) | 1 | ● | TSON-8 |
| TLE7250XSJ TLE8250XSJ | 2 Mbit/s | n/a | 1 | ● | DSO-8 |
| TLE7250XLE | 2 Mbit/s | n/a | 1 | ● | TSON-8 |
| TLE9250SJ² | 5 Mbit/s | \(< 20 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE9250LE² | 5 Mbit/s | \(< 20 @ 5 \text{ V power save mode}\) | 1 | ● | TSON-8 |
| TLE9250VSJ² | 5 Mbit/s | \(< 15 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE9250VLE² | 5 Mbit/s | \(< 15 @ 5 \text{ V power save mode}\) | 1 | ● | TSON-8 |
| TLE9250XSJ² | 5 Mbit/s | n/a | 1 | ● | DSO-8 |
| TLE9250XLE² | 5 Mbit/s | n/a | 1 | ● | TSON-8 |

#### No wake

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<tr>
<th>Product name</th>
<th>Transmission rate (max)</th>
<th>Low-power mode ( I_q ) [( \mu A )] (max)</th>
<th>Bus wake-up capability</th>
<th>Wake-up inputs</th>
<th>Number of channels</th>
<th>Bus failure management</th>
<th>CAN FD</th>
<th>Package²</th>
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<td>(&lt; 10 @ 5 \text{ V stand-by})</td>
<td>1</td>
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**NEW!**
| TLE9250SJSJ² | 5 Mbit/s | \(< 20 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE9250VLE² | 5 Mbit/s | \(< 20 @ 5 \text{ V power save mode}\) | 1 | ● | TSON-8 |
| TLE9250XSJ² | 5 Mbit/s | \(< 15 @ 5 \text{ V power save mode}\) | 1 | ● | DSO-8 |
| TLE9250XLE² | 5 Mbit/s | n/a | 1 | ● | TSON-8 |

¹ See packages on page 36
² Coming Q1/2017

[www.infineon.com/automotive-transceivers](http://www.infineon.com/automotive-transceivers)
## Product overview

<table>
<thead>
<tr>
<th>Product name</th>
<th>Transmission rate (max)</th>
<th>Low-power mode $I_q$ [µA] (max)</th>
<th>Bus wake-up capability</th>
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<tr>
<td><strong>Fault-tolerant CAN ISO 11898-3</strong></td>
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<tr>
<td>TLE6254-3G</td>
<td>125 kbit/s</td>
<td>$&lt; 65$ sleep mode</td>
<td>•</td>
<td>•</td>
<td>1</td>
<td>•</td>
<td></td>
<td>DSO-14</td>
</tr>
</tbody>
</table>

1) See packages on page 36
2) Coming Q1/2017

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Infineon provides FlexRay transceivers in SSOP-16 and TSSOP-14 for reliable communication in safety-related applications.

---

## Product overview

<table>
<thead>
<tr>
<th>Product name</th>
<th>Transmission rate (max)</th>
<th>$I_q$ [µA]</th>
<th>Bus wake-up capability</th>
<th>Wake-up inputs</th>
<th>Number of channels</th>
<th>Bus failure management</th>
<th>Package$^1$</th>
</tr>
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<tbody>
<tr>
<td><strong>FlexRay</strong></td>
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<tr>
<td>TLE9221SX</td>
<td>10 Mbit/s</td>
<td>$&lt; 45$ sleep mode</td>
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<td>SSOP-16</td>
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<tr>
<td>NEW! TLE9222PX</td>
<td>10 Mbit/s</td>
<td>$&lt; 45$ stand-by mode</td>
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<td>TSSOP-14</td>
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<tr>
<td>NEW! TLE9222LC$^2$</td>
<td>10 Mbit/s</td>
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<td>TSON-14</td>
<td></td>
</tr>
</tbody>
</table>

1) See packages on page 36
2) Coming Q1/2017

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www.infineon.com/automotive-transceivers

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System Basis Chips (SBCs)

Mid-Range System Basis Chip family supporting CAN Flexible Date-rate (FD) and Partial Networking (PN)

Infineon’s highly integrated Mid-Range System Basis Chip (SBC) family TLE926x offers best performance and scalability for various automotive applications. The Mid-Range SBCs feature up to three low-drop voltage regulators with 5 V or 3.3 V output voltage options for microcontroller, network transceivers, sensors and other peripherals’ power supply. As communication interfaces they incorporate one HS CAN transceiver (including Partial Networking option and Flexible Data-rate performance) and up to two LIN transceivers complying with the latest automotive standards and OEM requirements. The devices include diagnostic and supervision features for support of ECU functional safety concepts like under-voltage monitoring, window watchdog with reset, fail-safe operating mode, and fail-safe outputs. Four high-side switches are available in order to drive external loads, three wake-inputs and two General Purpose Input-Outputs (GPIOs) allow monitoring of inputs or activation of loads. The Mid-Range SBCs can be put into low power modes with full wake capability for very low quiescent current consumption in order to support applications that are connected permanently to the battery. All devices feature an exposed pad VQFN-48 (7 mm x 7 mm) power package supporting Automatic Optical Inspection (AOI). The entire family is pin-to-pin and software compatible, also to other Infineon SBC families, and is designed to withstand the severe conditions of automotive applications.

Key features

› Integrated low-drop voltage regulator (5 V or 3.3 V up to 250 mA)
› Integrated low-drop voltage regulator (5 V up to 100 mA), protected for off-board usage
› Voltage regulator (5 V, 3.3 V or 1.8 V) with external PNP transistor, protected for off-board usage or for load-sharing
› 1 high-speed CAN transceiver supporting FD communication up to 2 Mbit/s featuring CAN Partial Networking FD tolerant mode 1)
› 2 LIN transceivers LIN2.2/J2602
› 4 high-side outputs 7 Ω typ.
› 2 HV GPIOs, 3 HV wake inputs
› Interrupt, reset output
› Integrated fail-safe functions: 3 fail-safe outputs, watchdog, fail-safe operating modes
› 16-bit SPI for configuration and diagnostics
› Voltage, current and temperature protection and monitoring

Key benefits

› Reduced system cost through low component count and small PCB footprint
› Low-drop voltage regulators for on- and off-board supply
› Wide supply input voltage and temperature range
› High-performance network transceivers
› Flexible number of integrated LIN transceivers
› Very low quiescent current modes
› Very small package supporting AOI
› Pin and software compatibility amongst all family members
› Excellent EMC and ESD performance meeting major car OEM requirements

Target applications

› Body Control Modules (BCM) and Gateways
› Heating, ventilation and air conditioning (HVAC)
› Door, roof, tailgate, trailer and closure modules
› Passive keyless entry, passive start modules
› Seat control modules
› Light control modules
› Gear shifters and selectors

1) The CAN FD requirements for transceiver are not finalized. All statements regarding CAN FD are therefore based on Infineon’s today’s knowledge and expectation on the future CAN FD standard currently being worked out.

www.infineon.com/sbc
TLE9263 application diagram

Mid-Range SBC family overview
System Basis Chips (SBCs)

DC-DC System Basis Chip family supporting CAN Flexible Data-rate (FD)

Infineon’s highly integrated DC-DC System Basis Chip (SBC) family TLE927xQX offers optimal performance and scalability for various automotive applications. DC-DC SBC features a switch mode power supply voltage regulator (SMPS) with 5 V or 3.3 V output voltage, one 5 V low-drop voltage regulator, one HS CAN and up to four LIN transceivers complying with the latest automotive standards and OEM requirements. The devices include fail-safe features for supporting ECU functional safety concepts, high-voltage wake-input for monitoring inputs, along with a very low quiescent current in low-power modes with full wake-up capability. All devices feature an exposed pad VQFN-48 (7 mm x 7 mm) power package (supporting AOI). The entire family is not only pin-to-pin and software compatible, but also compatible with other Infineon SBC families, and is designed to withstand the severe conditions of automotive applications.

Key features
- Integrated high-efficiency SMPS buck converter with edge shading for an optimized EMC performance (5 V or 3.3 V up to 750 mA)
- The SMPS boost controller with edge shading for an optimized EMC performance enables functionality at a low supply voltage (V<sub>sup</sub> > 3 V) with external power switching
- Integrated low-drop voltage regulator (5 V up to 100 mA) protected for off-board usage
- 1 high-speed CAN transceiver ISO 11898-2/-5 supporting CAN Flexible Data-rate (CAN FD) up to 2 Mbps<sup>1)</sup> and suitable for chokeless operation up to 500 kbps
- Up to 4 LIN transceivers LIN2.2/J2602
- Fully compliant with “Hardware Requirements for LIN, CAN and FlexRay Interfaces in Automotive Applications” Revision 1.3, 2012-05-04
- 1 HV wake input for switch status monitoring
- Interrupt, reset output
- Integrated fail-safe functions:
  - 3 fail-safe outputs, 1 fail-safe input, watchdog, fail-safe operating modes
- 16-bit SPI for configuration and diagnostics (compatible with all new-generation SBC TLE926x and TLE927x)
- Voltage, current and temperature protection and monitoring

Key benefits
- High-efficiency SMPS buck and boost for supplying high current even at low battery voltage
- Low-drop voltage regulator for on- and off-board supply
- CAN FD transceiver suitable for chokeless operation
- Flexible number of integrated LIN transceivers
- Very low quiescent current
- Very small leadless package supporting AOI
- Pin compatibility among all family members
- Wide supply input voltage and temperature range
- Reduced system cost thanks to a low component count and less PCB space
- Excellent EMC and ESD performance meeting major automotive OEM requirements

Target applications
- Body control modules
- Gateway
- Climate control

<sup>1)</sup> The CAN FD requirements for transceivers are not finalized. All statements regarding CAN FD are therefore based on Infineon’s current knowledge and expectations of the future CAN FD standard currently being compiled.
TLE9273 application diagram

DC-DC SBC

- Battery
- V_{Bat}
- V_{i}
- Switches
- CAN bus
- LIN bus
- LIN bus
- LIN bus
- LIN bus

- Wake input
- Frame compare logic
- SPI
- State machine
- WD
- 3 FO
- DC-DC boost
- DC-DC buck
- RO
- FO
- 5 V/3.3 V

- Fail-safe
- SPI
- TxD, RxD
- INT
- RO

- Microcontroller
- Power IC
- Output drivers

DC-DC System Basis Chip family overview

- TLE9272QX(V33)
- State machine
- SPI
- Wake input
- WD
- Limp home
- 5 V/3.3 V
- DC-DC buck
- VCC1
- VCC2
- LDO2
- CAN
- LIN
- GND
- I_{GND}

- TLE9272QX(V33)
- State machine
- SPI
- Wake input
- WD
- Limp home
- 5 V/3.3 V
- DC-DC boost
- VCC1
- VCC2
- LDO2
- CAN
- LIN
- GND
- I_{GND}

- TLE9273QX(V33)
- State machine
- SPI
- Wake input
- WD
- Limp home
- 5 V/3.3 V
- DC-DC boost
- VCC1
- VCC2
- LDO2
- CAN
- LIN
- GND
- I_{GND}
System Basis Chips (SBCs)

Multi-CAN Power System Basis Chip family supporting CAN Flexible Data-rate (FD) and Partial Networking (PN)

Infineon’s Multi-CAN Power System Basis Chip (SBC) TLE9278 family offers the highest level of integration at smallest footprint for automotive applications requiring multiple channels of CAN transceivers like gateways and high-end Body Control Modules (BCM).

**Key features**
- 4x CAN Flexible Data-rate transceivers up to 5 Mbit/s
- Partial Networking w/ “-3” variants
- Buck regulator up to 750 mA
- Boost controller at 6.5/8/10/12 V
- 16-bit serial peripheral interface
- Time-out/window watchdog
- Failsafe-output
- Low power modes
- 7 x 7 mm VQFN package

A high-efficient Switch Mode Power supply (SMPS) buck regulator provides an external 5 V or 3.3 V output voltage at up to 750 mA while an additional DC-DC boost converter supports applications or conditions at low supply input voltages.

**Key benefits**
- Highly integrated solution for multi-Channel CAN applications
- Highly efficient power supply
- High power for strong processors
- Tolerant to low voltage line drops
- Easy configuration and control
- Advanced diagnostics functions
- Failsafe functions for safety
- Power saving modes
- Minimal PCB footprint

TLE9278 application diagram

Central gateway

+12 V from battery →

CAN bus

Body
powertrain
safety
comfort

ADAS
OBD
telematics

CAN transceiver TLE925x

Ethernet PHY

Multi-CAN
Power SBC
TLE9278

Supply and communication

eMMC/SDIO

Multi-CAN
(CAN-FD)

32-bit
Multicore/Lockstep
AURIX™

Serial
interfaces

1 Gbit
Ethernet

Central
OTA storage
## Body System ICs – System Basis Chips product overview

<table>
<thead>
<tr>
<th>Product Name</th>
<th>Family Name</th>
<th>Transmission rate</th>
<th>( I_{Q} ) [( \mu A )]</th>
<th>( V_{DD} ) [V]</th>
<th>( V_{TTA} ) [V]</th>
<th>( V_{TTB} ) [V]</th>
<th>CAN</th>
<th>LIN</th>
<th>Wake-up input</th>
<th>Watchdog</th>
<th>Output driver</th>
<th>Package</th>
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</thead>
<tbody>
<tr>
<td>TLE9260QX(V33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>50 (typ) sleep mode ( (V_{REG} = 1 \text{ on}) )</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>–</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>–</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
</tr>
<tr>
<td>TLE9261QX(V33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>50 (typ) sleep mode ( (V_{REG} = 1 \text{ on}) )</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V (3.3 V/1.8 V avail. on V33 variant)</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>–</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
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<tr>
<td>TLE9262QX(V33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>50 (typ) sleep mode ( (V_{REG} = 1 \text{ on}) )</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V (3.3 V/1.8 V avail. on V33 variant)</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>1x</td>
<td>LIN 2.x and SAE J2602</td>
<td>3 high-voltage (cyclic sense)</td>
</tr>
<tr>
<td>TLE9263QX(V33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>50 (typ) sleep mode ( (V_{REG} = 1 \text{ on}) )</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V (3.3 V/1.8 V avail. on V33 variant)</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>2x</td>
<td>LIN 2.x and SAE J2602</td>
<td>3 high-voltage (cyclic sense)</td>
</tr>
<tr>
<td>TLE9271QX(V33)</td>
<td>DC-DC SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>55 (typ) sleep mode ( (V_{REG} = 2 \text{ off}) )</td>
<td>750 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>–</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>2x</td>
<td>LIN 2.x and SAE J2602</td>
<td>1 high-voltage</td>
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<tr>
<td>TLE9272QX(V33)</td>
<td>DC-DC SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>55 (typ) sleep mode ( (V_{REG} = 2 \text{ off}) )</td>
<td>750 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>–</td>
<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
<td>3x</td>
<td>LIN 2.x and SAE J2602</td>
<td>1 high-voltage</td>
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<tr>
<td>TLE9273QX(V33)</td>
<td>DC-DC SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode ( (V_{REG} = 1 \text{ off}) )</td>
<td>55 (typ) sleep mode ( (V_{REG} = 2 \text{ off}) )</td>
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<td>100 mA @ 5 V</td>
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<td>1x</td>
<td>High-speed CAN (^{ii}) ISO 11898-5</td>
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<td>LIN 2.x and SAE J2602</td>
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<tr>
<td>TLE9278QX</td>
<td>Multi-Can Power SBC</td>
<td>5 Mbit/s</td>
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<td>55</td>
<td>750 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V/1.8 V/1.2 V</td>
<td>4x</td>
<td>CAN FD</td>
<td>1 high-voltage</td>
<td>Yes (window watchdog)</td>
<td>1 fail-safe output</td>
<td>VQFN-48</td>
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<tr>
<td>TLE9278QX V33</td>
<td>Multi-Can Power SBC</td>
<td>5 Mbit/s</td>
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<td>400 mA @ 5 V/3.3 V/1.8 V/1.2 V</td>
<td>4x</td>
<td>CAN FD</td>
<td>1 high-voltage</td>
<td>Yes (window watchdog)</td>
<td>1 fail-safe output</td>
<td>VQFN-48</td>
</tr>
</tbody>
</table>

1) See packages on page 36
2) CAN FD up to 2 Mbit/s
3) CAN PN FD tolerant
4) Coming Q2/2017
## System Basis Chips (SBCs)

### Body System ICs – System Basis Chips product overview (cont’d)

<table>
<thead>
<tr>
<th>Product Name</th>
<th>Family Name</th>
<th>Transmission Rate</th>
<th>Iq [µA]</th>
<th>IQ [µA]</th>
<th>Vreg 1 [V]</th>
<th>Vreg 2 [V]</th>
<th>Vreg 3 [V]</th>
<th>CAN</th>
<th>LIN</th>
<th>Wake-up inputs</th>
<th>Watchdog</th>
<th>Output drivers</th>
<th>Package1</th>
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<tbody>
<tr>
<td>TLE9260-3QX(33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode (Vreg 1 off)</td>
<td>50 (typ) stop mode (Vreg 1 on)</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>–</td>
<td>1x High-speed CAN</td>
<td>–</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
<td>4x high-side switch 150 mA, 3 fail-safe outputs</td>
<td>VQFN-48</td>
</tr>
<tr>
<td>TLE9261-3QX(33)</td>
<td>Mid-range SBC</td>
<td>2 Mbit/s (CAN) 20 kbit/s 10.4 kbit/s (LIN)</td>
<td>30 (typ) sleep mode (Vreg 1 off)</td>
<td>50 (typ) stop mode (Vreg 1 on)</td>
<td>250 mA @ 5 V (3.3 V on V33 variant)</td>
<td>100 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V (3.3 V/1.8 V avail. on V33 variant)</td>
<td>1x High-speed CAN</td>
<td>–</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
<td>4x high-side switch 150 mA, 3 fail-safe outputs</td>
<td>VQFN-48</td>
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<tr>
<td>TLE9262-3QX(33)</td>
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<td>50 (typ) stop mode (Vreg 1 on)</td>
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<td>100 mA @ 5 V</td>
<td>400 mA @ 5 V/3.3 V (3.3 V/1.8 V avail. on V33 variant)</td>
<td>1x High-speed CAN</td>
<td>2x LIN 2.x and SAE J2602</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
<td>4x high-side switch 150 mA, 3 fail-safe outputs</td>
<td>VQFN-48</td>
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<tr>
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<td>30 (typ) sleep mode (Vreg 1 off)</td>
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<td>1x High-speed CAN</td>
<td>2x LIN 2.x and SAE J2602</td>
<td>3 high-voltage (cyclic sense)</td>
<td>Yes (window watchdog)</td>
<td>4x high-side switch 150 mA, 3 fail-safe outputs</td>
<td>VQFN-48</td>
</tr>
<tr>
<td>TLE9278-3QX</td>
<td>Multi-CAN Power SBC</td>
<td>5 Mbit/s</td>
<td>30</td>
<td>55</td>
<td>750 mA @ 5 V</td>
<td>400 mA @ 3.3 V/1.8 V/1.2 V</td>
<td>4x CAN FD</td>
<td>1 high-voltage</td>
<td>Yes (window watchdog)</td>
<td>1 fail-safe output</td>
<td>1 fail-safe output</td>
<td>VQFN-48</td>
<td></td>
</tr>
<tr>
<td>TLE9278-3QX-V33</td>
<td>Multi-CAN Power SBC</td>
<td>5 Mbit/s</td>
<td>30</td>
<td>55</td>
<td>750 mA @ 3.3 V</td>
<td>400 mA @ 3.3 V/1.8 V/1.2 V</td>
<td>4x CAN FD</td>
<td>1 high-voltage</td>
<td>Yes (window watchdog)</td>
<td>1 fail-safe output</td>
<td>1 fail-safe output</td>
<td>VQFN-48</td>
<td></td>
</tr>
</tbody>
</table>

1) See packages on page 36
2) CAN FD up to 2 Mbit/s
3) CAN PN FD tolerant
4) Coming Q2/2017
Infineon® Embedded Power ICs

System-on-Chip motor control

Infineon® Embedded Power ICs are specifically designed to enable mechatronic motor control solutions for a range of motor control applications, where a small package form factor and a minimum number of external components are essential. Such applications include window lift, sunroof, wiper, fuel pump, HVAC fans, engine cooling fan and water pumps, to name but a few.

Produced on Infineon’s first-in-industry automotive-qualified Smart Power technologies, the Infineon Embedded Power System-on-Chip (SoC) solutions offer an unmatched level of integration of all functions required to sense, control and actuate a motor.

The Infineon® Embedded Power ICs integrate on single die the microcontroller, the non-volatile flash memory, the analog and mixed signal peripherals, the communication interfaces along with the driving stages needed for either relay, half-bridge or full-bridge DC and BLDC motor applications.

Selection tree – Infineon Embedded Power IC motor control

Infineon® Embedded Power IC

- Relay motor control
  - TLE9842QX
  - TLE9842-2QX
  - TLE9843QX
  - TLE9843-2QX
  - TLE9844QX
  - TLE9844-2QX
- PN half-bridge motor control
  - TLE9845QX
- H-bridge motor control
  - TLE9861QXA20
  - TLE9867QXA20
  - TLE9867QXA40
  - TLE9869QXA20
- 3-phase bridge motor control
  - TLE9871QXA20
  - TLE9877QXA20
  - TLE9877QXA40
  - TLE9879QXA20
  - TLE9879QXA40

www.infineon.com/embeddedpower
3rd generation: relay driver IC with integrated microcontroller

The TLE984x product family brings together the ARM® Cortex®-M0 core and the market proven peripherals of its predecessor TLE983x (XC800 based relay driver). It integrates on a single die all the necessary functions to sense, control and actuate a motor via a relay or via a PN MOSFET half-bridge.

Produced on Infineon’s first-in-industry automotive-qualified 130 nm Smart Power technology, the Infineon Embedded Power system-on-chip solution offers an unmatched level of integration as well as system cost to performance optimization for the target application segments.

**TLE984x family offers**
- Two protected low-side switches (min. 270 mA)
- Up to two protected high-side switches (min. 150 mA)
- Up to five high-voltage inputs with wake-up functionality
- Integrated LIN transceiver compatible with LIN 2.2 and SAEJ2602
- Two full duplex serial interface (UART) with LIN support
- Two Synchronous Serial Channel (SSC), compatible with SPI
- On-chip oscillator and PLL for clock generation
- Measurement unit:
  - 8-bit ADC module with 7 multiplexed inputs for system supervision
  - 10-bit ADC module with 13 multiplexed inputs
  - On-chip temperature and battery voltage measurement
- Independent programmable window watchdog
- 5 V/1.5 V internal supplies
- External supply (VDDEXT): 5 V ±2% @ 20 mA
- Power saving modes
  - MCU slow-down mode
  - Sleep mode
  - Stop mode
  - Cyclic wake-up from sleep mode or stop mode

The TLE984x family concept offers scalability in terms of flash memory sizes ranging from 36 kB to 64 kB with pin-compatible devices.

The TLE984x family is the successor of the TLE983x product family and specifically designed to fit to a wide range of LIN-slave motor control applications such as window lifts, wipers, sun roofs, fans and blowers to name a few.

The TLE984x product family is offered in a space saving VQFN-48 package.

**Features of the microcontroller and its peripherals**
- 32-bit ARM® Cortex®-M0 core, up to 25/40 MHz clock frequency
- 36 KB to 64 KB flash memory for code and data
- Boot ROM for startup firmware and flash routines
- Up to 4 kByte RAM memory
- Thumb® + Thumb-2® Instruction Set
- Nine 16-bit timers
- Capture/compare unit for PWM signal generation (CCU6) with 2 x 16-bit timers

**General characteristics**
- Operating supply voltage \( V_S = 5.5 \) to 28 V, maximum rating 40 V
- Extended operating range \( V_S = 3.0 \) to 28 V, MCU/flash fully functional
- Wide operating temperature range: \( T_J: -40°C \) up to 150°C

**Applications**
- Window lift
- Sun roof
- Wiper
- Fan/blower control
- Relay motor via relay
- Switch panel interface

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Infineon® Embedded Power ICs

**TLE984x product overview**

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<tr>
<th>Product name</th>
<th>Core</th>
<th>Flash [kB]</th>
<th>RAM [kB]</th>
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1) See packages on page 36

Embedded Power ICs TLE984xQX: smart window lift application diagram
Infineon has combined its wealth of experience in motor control drivers for automotive applications with an industry-standard core. The unique result, our 3rd generation Embedded Power IC based on ARM® Cortex®-M cores, addresses a wide range of smart 2-phase DC motor control applications like, sunroof, power window lift, electrical pumps, electrical fans.

Produced on Infineon’s first-in-industry automotive-qualified 130 nm Smart Power technology, the Infineon Embedded Power system-on-chip solutions offer an unmatched level of integration and system cost to performance to optimization for the target application segments.

The TLE986x family offers scalability in terms of flash memory sizes and MCU system clock frequency supporting a wide range of motor control algorithms. It uses the same MCU and peripherals as the TLE987x family, 3-phase driver, enabling design synergies between DC and BLDC motor control applications.

### Features of the microcontroller
- 32-bit ARM® Cortex®-M3 Core, up to 40 MHz clock frequency
- 36 KB to 128 KB flash memory
- Up to 6 KB RAM memory
- Harvard architecture
- Thumb®-2 Instruction Set and hardware divide and multiplication unit
- Four 16-bit timers
- Capture/compare unit for PWM signal generation (CCU6) with 2x 16-bits timers

### General characteristics
- Operating supply voltage $V_S = 5.5$ to 28 V, maximum rating 40 V
- Extended operating range $V_S = 3.0$ to 28 V, MCU/flash fully functional
- ESD performance
  - up to 2 kV / handling on all pins
  - 4 kV @ HV inputs
  - 6 kV @ LIN pin
- Overvoltage device clamp (load dump ruggedness) up to 40 V
- Wide operating temperature range: $T_J$ -40°C up to 150°C

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Infineon® Embedded Power ICs

Block diagram

TLE986x 32-bit µC with 2-phase MOSFET Gate Driver for DC motors

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¹) See packages on page 36
Infineon has combined its wealth of experience in motor control drivers for automotive applications with all the benefits of an industry-standard core. The unique result, our 3rd generation Embedded Power IC based on ARM® Cortex®-M cores, addresses a wide range of smart 3-phase brushless DC motor control applications like, fuel pumps, HVAC fans, engine cooling fans, electrical water pumps. Produced on Infineon’s first-in-industry automotive-qualified 130 nm Smart Power technology, the Infineon Embedded Power system-on-chip solutions offer an unmatched level integration and system cost to performance to optimization for the target application segments.

The TLE987x family offers scalability in terms of flash memory sizes and MCU system clock frequency supporting a wide range of motor control algorithms, either sensor-based or sensor-less. It uses the same MCU and peripherals as the TLE986x family, 2-phase driver, enabling design synergies between DC and BLDC motor control applications.

### TLE987x family offers
- Six current programmable drivers with charge pump for N-Channel MOSFET
- Integrated LIN transceiver compatible with LIN 2.2 and SAE J2602
- Two full duplex serial interface (UART) with LIN support
- Two Synchronous Serial Channel (SSC)
- On-chip OSC and PLL for clock generation
- One high-voltage monitoring input with wake-up functionality
- High-speed operational amplifier for motor current sensing via shunt
- Measurement unit
  - 8-bit ADC module with 10 multiplexed inputs
  - 10-bit ADC module with 8 multiplexed inputs, 5 external analog inputs
  - On-chip temperature and battery voltage measurement unit
- Independent programmable window watchdog
- 5 V/1.5 V internal supplies
- External supply (\(V_{DDEXT}\)): 5 V ±2% @ 20 mA
- Power saving modes
  - MCU slow-down mode
  - Sleep mode
  - Stop mode
  - Cyclic wake-up sleep mode

### Features of the microcontroller
- 32-bit ARM® Cortex®-M3 Core, up to 40 MHz clock frequency
- 36 KB to 128 KB flash memory
- Up to 6 KB RAM memory
- Harvard architecture
- Thumb®-2 Instruction Set and hardware divide and multiplication unit
- Four 16-bit timers
- Capture/compare unit for PWM signal generation (CCU6) with 2x 16-bits timers

### General characteristics
- Operating supply voltage \(V_S = 5.5\) to 28 V, maximum rating 40 V
- Extended operating range \(V_S = 3.0\) to 28 V, MCU/flash fully functional
- ESD performance
  - up to 2 kV / handling on all pins
  - 4 kV @ HV inputs
  - 6 kV @ LIN pin
- Overvoltage device clamp (load dump ruggedness) up to 40 V
- Wide operating temperature range:
  \(T_J\): -40°C up to 150°C
Infineon® Embedded Power ICs

Block diagram

TLE987x 32-bit μC with 3-phase MOSFET Gate Driver for BLDC motors

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¹ See packages on page 36
The AURIX™ TC3xx microcontrollers are also well-suited to safety-critical applications ranging from airbag, braking and power steering to sensor based systems using radar or camera technologies. The combination of performance and a powerful safety architecture makes the family ideal fit for domain control and data fusion applications supporting the next levels of autonomous driving. Thanks to the Infineon deep system know-how of the targeted applications, AURIX™ TC3xx comes with a high integration of external functionalities and components allowing further bill of material cost optimization, compact board designs and fail operational systems for autonomous driving.

As a host controller in gateway and telematics applications, AURIX™ TC3xx microcontrollers support the latest communications interfaces and feature a Gigabit Ethernet interface, up to 12 ISO11898-1 compliant CAN-FD channels and, up to 24 LIN channels. An additional eMMC interface for external Flash interfacing enables local data storage supporting software-over-the-air update concepts.
### AURIX™ 1st generation family package scalability

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- Upgrade/downgrade with pin-compatible packages
- Advanced package technologies deliver the best price/performance ratio
- Customers can choose between different devices in the same pin-compatible package

### TriCore™ upgrade paths

- LFBGA-292 and LFBGA-516 are ball compatible so that customers can build one PCB for both packages
AURIX™ MultiCAN
› Up to 6 CAN nodes with FD support available
› CAN standard V2.0 B active
› Full AURIX™ support for ISO11898-1:2015
› Specific AURIX™ variants support ISO11898-1 DIS 2015
› Resonator ready with asynchronous operation and choice of clock source
› Frequency scaling without baud rate change
› Energy saving: pretended networking and partial networking (ISO11898-6 transceiver support) support (also in CAN FD mode)
› Safety support: total amount of bus errors countable
› Message objects can be freely assigned among the nodes
› Configurable FIFO length, automatic gateway mode support
› Acceptance mask filtering for each message object

Ethernet

Highlights
› MAC integrated in µC
› IEEE 802.3-2002 for Ethernet with support of IP, TCP/IP, UDP ...
› Real-time stamping support (IEEE 1588-2008) for clock synchronization
› Standard MII and RMII interfaces to PHY
› Fast Ethernet w/ 100 Mbit
› AUTOSAR V4 features supported
› Automatic CRC checksum and padding support
› AVB support

www.infineon.com/aurix
Support tools

Support tools Automotive transceivers

The universal CAN demoboard
The HS CAN transceiver demoboard can be used for all standard HS CAN transceivers, which fulfill the OEM required standard pinout for 8-pin and 14-pin DSO packages. Additionally it is also suited for CAN transceivers with Partial Networking capability as well as CAN FD transceivers.

Further information
User manuals with software and hardware recommendation, FAQs, data sheets along with development tools can be found at www.infineon.com/automotive-transceivers

Support tools System

Support tools System Basis Chips (SBCs)

Midrange SBC board
This demo board enables device evaluation of the Mid-Range SBC product family and accelerates the design-in phase.
The evaluation board can be connected to the “UIO STICK” (Power Easy Kit Lite) and controlled via USB using a powerful and intuitive Graphical User Interface (GUI) installed on your computer.

Multi-CAN SBC board
This demo board enables device evaluation of the Multi-CAN Power SBC product family and accelerates the design-in phase.
The evaluation board can be connected to the “UIO STICK” (Power Easy Kit Lite) and controlled via USB using a powerful and intuitive Graphical User Interface (GUI) installed on your computer.

Further information
User manuals with software and hardware recommendation, FAQs, data sheets along with development tools can be found at www.infineon.com/sbc
Support tools Embedded Power

TLE984X evaluation board
The TLE984x evaluation board offers complete evaluation of all functions and peripherals of the TLE984x product family.

TLE9845 evaluation board
The TLE9845 evaluation board offers complete evaluation of all functions and peripherals of the TLE9845QX variant of the TLE984x product family.

H-bridge driver IC with integrated microcontroller evaluation kit TLE986x
The TLE986X EVALB_JLINK offers complete evaluation of all functions and peripherals of the TLE986x product family and allows direct connection to a DC motor via MOSFETS in H-bridge configuration, it includes: H-bridge for DC motor drive, UART and LIN for communication, direct access to all device I/Os and a J-link debugger.

B6-bridge driver IC with integrated microcontroller evaluation kit TLE987x
The TLE987X EVALB_JLINK offers complete evaluation of all functions and peripherals of the TLE987x product family and allows direct connection to a BLDC motor via MOSFETS in B6-bridge configuration, it includes: B6-bridge for BLDC motor drive, UART and LIN for communication, direct access to all device I/Os and a J-link debugger.

Infineon® Embedded Power ICs are supported by a complete development tool chain provided by Infineon and third party vendors. The tool chain includes compilers, debuggers, evaluation boards, LIN low-level drivers and configuration tools as well as variety of example software code.

Further information
User manuals with software and hardware recommendation, FAQs, data sheets along with development tools can be found at www.infineon.com/embeddedpower
Support tools microcontrollers

ACT– AURIX™ configuration tool

ACT is a powerful tool that helps engineers to jump-start programming of Infineon microcontrollers.

Key feature
› Altium TASKING VX TriCore™ lite version including build-in
  – AURIX™ pin mapping incl. interactive package view
  – AURIX™ ILLD (Low-Level Driver)
  – AURIX™ OSEK

Infineon Tricore™ family starter kits are powerful evaluation systems that enable evaluation and development well before the target hardware is available. They offer a solid platform for both hardware and software engineers to evaluate and prototype designs that are closely aligned with their final applications.

Our kits Include
› Full-featured evaluation board
› USB cable
› Easy connectivity to all peripheral modules
› Extension board
› Development tools for evaluation such as compilers, debuggers and DAVE™
› Technical documentation – user manuals, architecture manuals, application notes, data sheets, board documentation

Further information on TriCore™ starter kits:
http://ehitex.com/starter-kits/for-tricore
Package information

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<td>LFBGA-516</td>
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<td>TSSOP-14</td>
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Service hotline

Infineon offers its toll-free 0800/4001 service hotline as one central number, available 24/7 in English, Mandarin and German.

› Germany .................... 0800 951 951 951 (German/English)
› China, mainland ........ 4001 200 951 (Mandarin/English)
› India ......................... 000 800 4402 951 (English)
› USA .......................... 1-866 951 9519 (English/German)
› Other countries ........... 00* 800 951 951 951 (English/German)
› Direct access .............. +49 89 234-0 (interconnection fee, German/English)

* Please note: Some countries may require you to dial a code other than "00" to access this international number. Please visit www.infineon.com/service for your country!

Mobile product catalog
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